

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)}TYP$	I_D
60V	2Ω@10V	220mA
	2.5Ω@4.5V	



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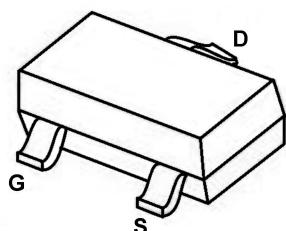
Feature

- High power and current handing capability
- Surface mount package
- ESD protected 2KV

Application

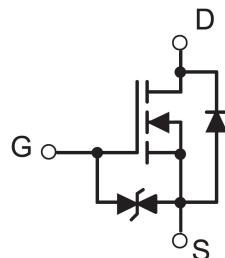
- Battery Switch
- DC/DC Converter

Package

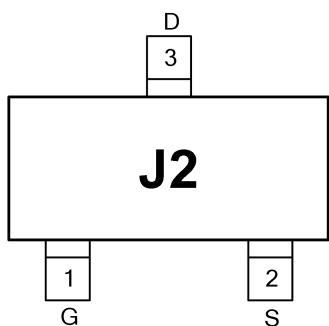


SOT-23

Circuit diagram



Marking



J2

:Device Code

Order Information

Device	Package	Unit/Tape
BSS139	SOT-23	3000

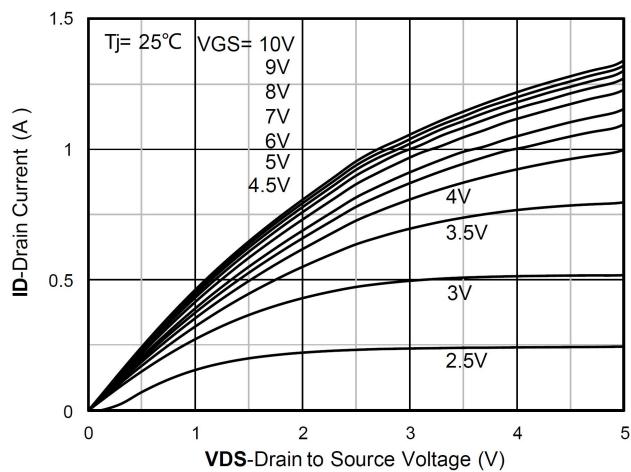
Absolute maximum ratings (Ta=25°C, unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	60	V
Gate-Source Voltage	V _{GSS}	±20	V
Continuous Drain Current	I _D	220	mA
Pulse Drain Current Tested	I _{DM}	880	mA
Power Dissipation	P _D	350	mW
Thermal Resistance Junction-to-Ambient	R _{θJA}	357	°C/W
Storage Temperature Range	T _{STG}	-55 to 150	°C
Operating Junction Temperature Range	T _J	-55 to 150	°C

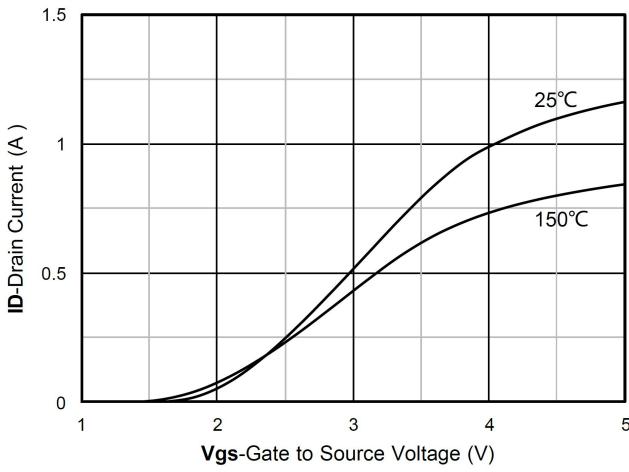
Electrical characteristics (Ta=25°C, unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V , ID=250μA	60	-	-	V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =48V , V _{GS} =0V	-	-	1	uA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±20V , V _{DS} =0V	-	-	±10	uA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , ID=250μA	0.7	1	1.45	V
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} =10V, ID =500mA	-	2	5	Ω
		V _{GS} =4.5V, ID =200mA	-	2.5	8	
Dynamic characteristics						
Input Capacitance	C _{iss}	V _{DS} =25V , V _{GS} =0V , f=1MHz	-	12	-	pF
Output Capacitance	C _{oss}		-	6	-	
Reverse Transfer Capacitance	C _{rss}		-	2.5	-	
Total Gate Charge	Q _g	V _{DS} =10V , V _{GS} =15V , ID=1A	-	1.34	-	nC
Gate-Source Charge	Q _{gs}		-	0.29	-	
Gate-Drain Charge	Q _{gd}		-	0.2	-	
Switching Characteristics						
Turn-On Delay Time	t _{d(on)}	VDD=15V VGS=10V , RG=2.3Ω , ID=1A	-	5	-	nS
Turn-On Rise Time	t _r		-	18	-	
Turn-Off Delay Time	t _{d(off)}		-	8	-	
Turn-Off Fall Time	t _f		-	14	-	
Source-Drain Diode characteristics						
Diode Forward Voltage	V _{SD}	V _{GS} =0V , IS=1A , TJ=25°C	-	-	1.2	V

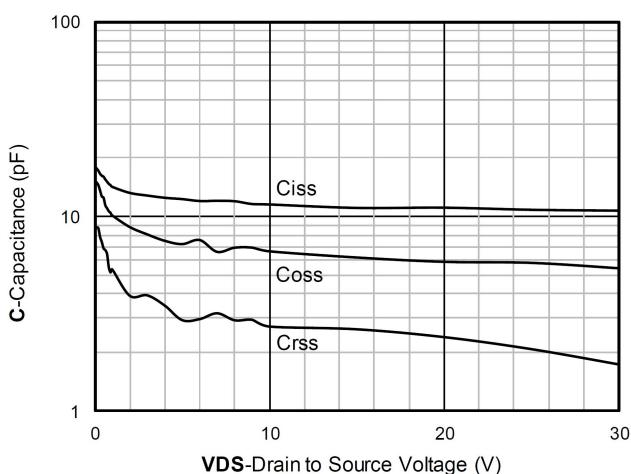
Typical Characteristics



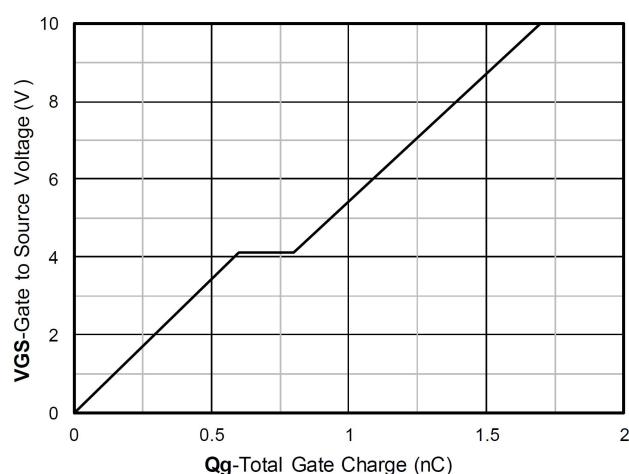
Output Characteristics



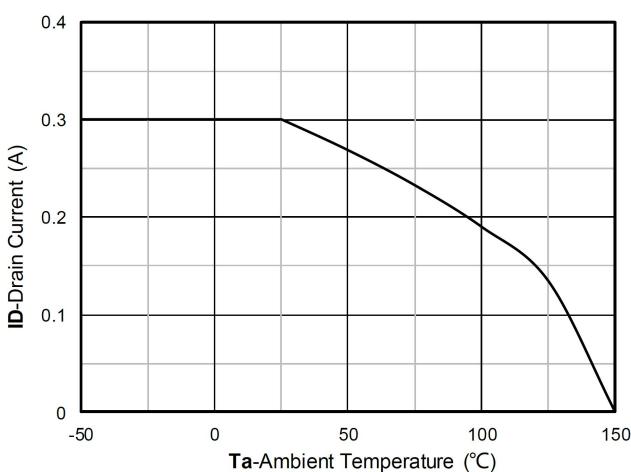
Transfer Characteristics



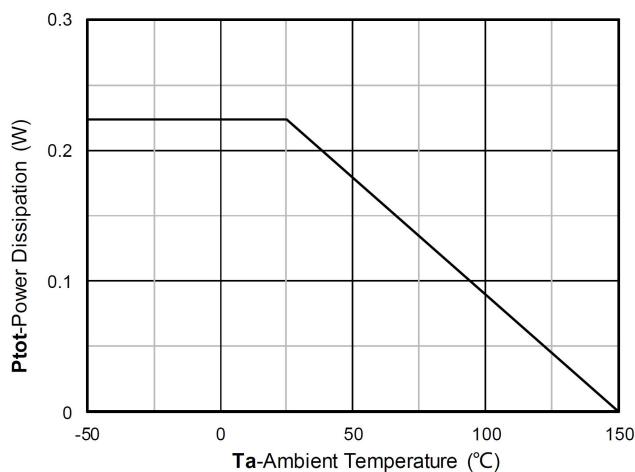
Capacitance Characteristics



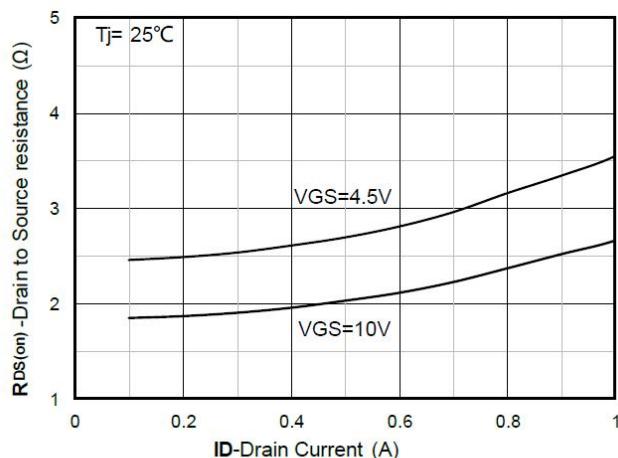
Gate Charge



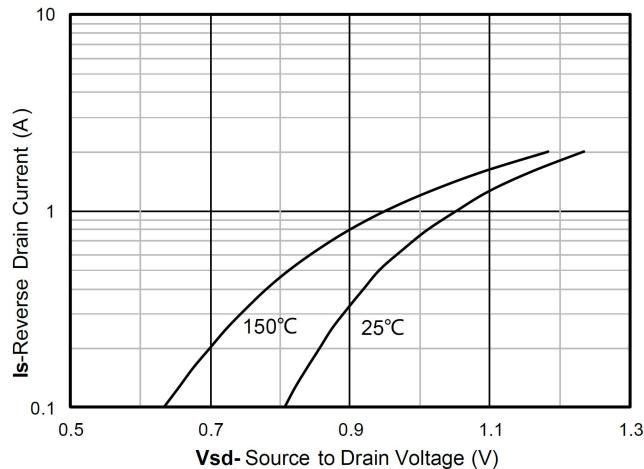
Current dissipation



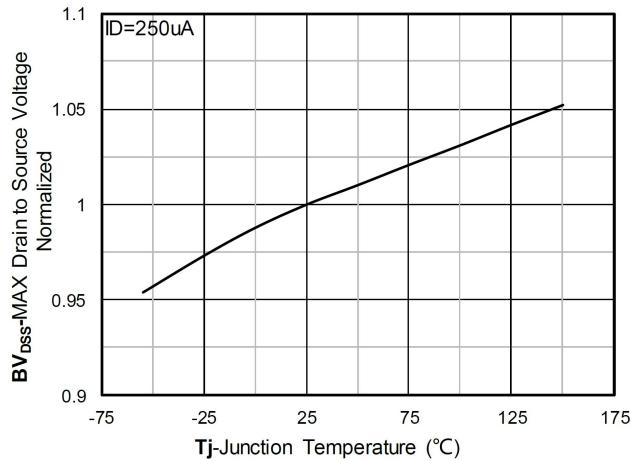
Power dissipation



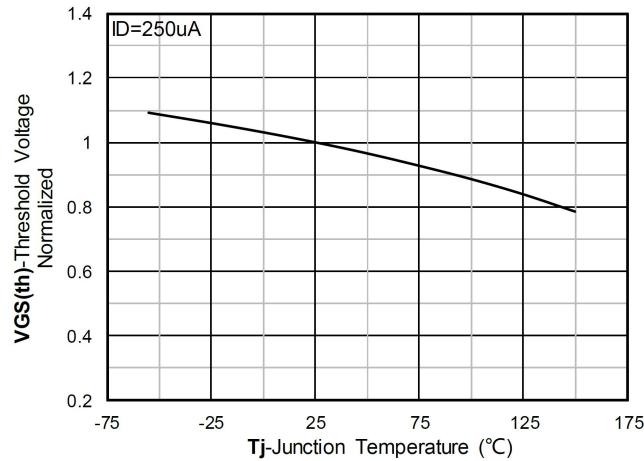
$R_{DS(on)}$ VS Drain Current



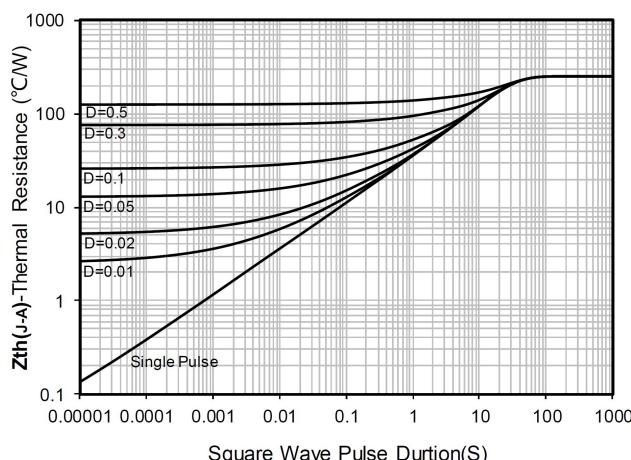
Forward characteristics of reverse diode



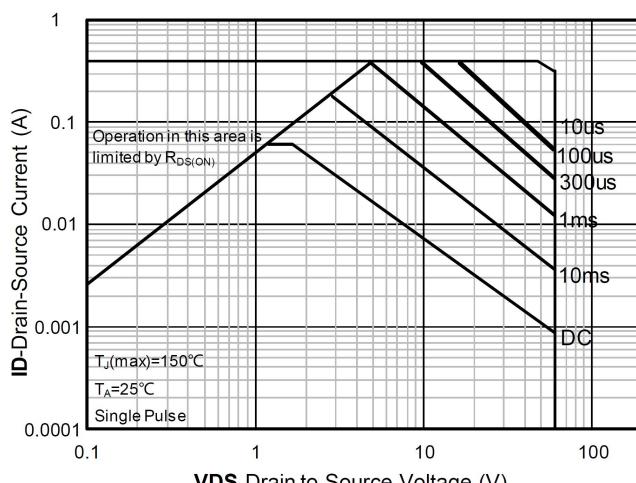
Normalized breakdown voltage



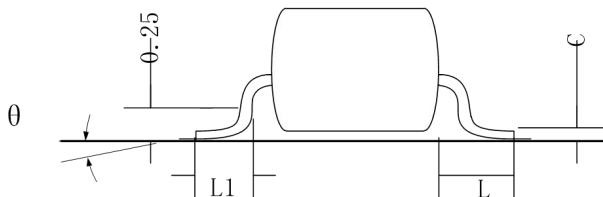
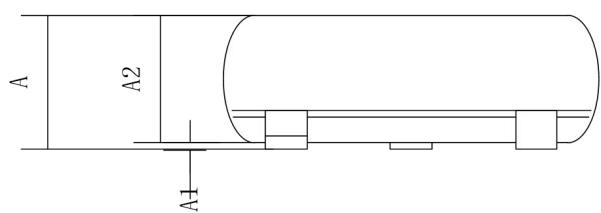
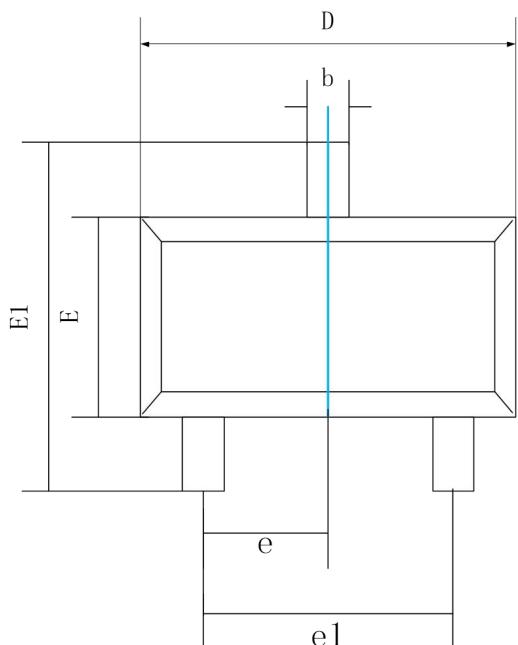
Normalized Threshold voltage



Maximum Transient Thermal Impedance



Safe Operation Area

SOT-23 Package Information


Symbol	Dimensions In Millimeters	
	Min.	Max.
A	0.90	1.15
A1	0.00	0.10
A2	0.90	1.05
b	0.30	0.50
c	0.08	0.15
D	2.80	3.00
E	1.20	1.40
E1	2.25	2.55
e	0.95 REF.	
e1	1.80	2.00
L	0.55 REF.	
L1	0.30	0.50
θ	0°	8°